



12-18-00

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PATENT

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12/15/00
Date

Nicole Bailey

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s) : Batz, Jr., et al.
Application No. : 09/390,501 ✓
Filed : September 3, 1999 ✓
Title : Methods for Plating Semiconductor Workpieces Using A
Workpiece-Engaging Electrode Assembly With Sealing Boot

Examiner : Smith Hicks, E

Art Unit : 1741

Semitool Ref. No. : P97-0013US3

Date : December 13, 2000

Commissioner for Patents
Washington, DC 20231

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APPOINTMENT OF ASSOCIATE POWER OF ATTORNEY

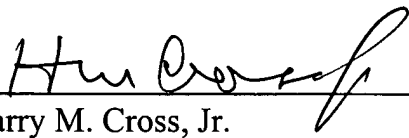
Sir:

I, Harry M. Cross, Jr., Esq., attorney of record in the above-identified application, appoint as associate attorneys Paul T. Parker, Registration No. 38,264; John M. Wechkin, Registration No. 42,216 and Edward S. Hotchkiss, Registration No. 33,904, all members of the firm of Perkins Coie LLP, Customer Number 25096.

It is requested that correspondence continue to be addressed to the firm of record.

Respectfully submitted,

Perkins Coie LLP



Harry M. Cross, Jr.
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